

Thermal properties of wood-based panels: specific heat determination

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Abstract Ensuring reliability of data on thermal properties of wood-based panels is important for manufacturing processes, especially when it is recommended to shorten the cooling phase and stack the panels in hot conditions. Prediction of the heat transfer during cooling phase and normal or hot stacking based on accurate data is essentially important for attaining panels of required properties. The thermal properties are also required when designing houses, especially low-energy or passive ones. Therefore, a water calorimeter was adequately designed and constructed to ensure improvement in the accuracy of the specific heat measurements. The calorimeter was used to determine the specific heat. The attained accuracy estimated by the relative error was significantly increased, and the error values were less than 2 % for all types of the investigated particleboard and OSB. In case of low-density fiberboard (LDF), the maximum value of the relative error did not exceed 4 %. It was also shown that high accuracy required for the specific heat measurements was achieved for experiments in which high-mass samples were used, in contrast to measurements for such samples in traditional DSC systems. The results for the specific heat were within the range from 1420 to 1450 J/kg K for LDF and all types of particleboard. The effect of the investigated material density on the specific heat was not found. The only exception was in case of OSB for which the specific heat was ca. 1550 J/kg K, and it was approximately 100 J/kg K higher when compared to other panels.

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Introduction

Credible data on thermal properties of wood-based panels are of special significance also during manufacturing processes, e.g., for controlling the cooling phase which is required before stacking materials already produced. Cooling of panels is especially important in the case of composites bonded with urea–formaldehyde or melamine–urea–formaldehyde resins as temperature of a stack as high as 65–70 °C may result in hydrolysis of the resins, and therefore, it can lead to the reduction in the bonding strength of particles within panels (e.g., Chapman 2006; Irle and Barbu 2010). However, in the case of panels bonded with phenol–formaldehyde resins it is often recommended to shorten the cooling phase and stack the panels in hot conditions. The hot stacking is used to complete the curing process of phenol–formaldehyde resins, especially in the core layers of the panels (e.g., Carvalho et al. 2010). Therefore, the accurate prediction of heat transfer during cooling phase as well as during normal or hot stacking has special importance for obtaining the required properties of the panels.

High accuracy of thermal properties of wood-based panels is also required when designing houses, especially low-energy or passive ones. The proper application of materials forming thermal envelope of a building is one of the most important problems which is faced during the design process (e.g., Kosny et al. 2014; Upton et al. 2008). The primary goal of the thermal envelope is to reduce heat losses of a building in winter and heat gains in summer. The heat transfer reduction can be relatively easily obtained; however, inaccurate data on the thermal properties of materials may cause unfavorable and uncontrolled local increase in heat transfer, which is usually called heat bridges (Piot et al. 2011). The phenomenon is usually associated with water condensation at surfaces with low temperature. It results in dramatic decrease in insulating properties of the materials due to increase in their moisture content. Moreover, the process is self-propelling as the increase in moisture content causes further increase in thermal conductivity of the materials.

The thermal properties of wood-based panels which are required for heat transfer calculations usually consist of specific heat and thermal conductivity. The two properties are, however, determined with different experimental methods. The specific heat is traditionally measured with calorimetric methods (e.g., Baryeh 1997), while the thermal conductivity values are obtained by the application of various methods based on principles of steady-state or transient heat transfer (e.g., Sonderegger and Niemz 2009; Zhou et al. 2013). In the last decades, the development of the calorimetric methods resulted in constructing automated systems for thermodynamic analysis of materials based on the technique of differential scanning calorimetry (DSC). The most important disadvantage of the DSC systems, as applied for investigating wood-based panels, is mass of samples usually being less than 100 mg (e.g., Menczel et al. 2009; Wolfinger et al. 2001; Ghazi Wakili et al. 2003). The low mass of samples has special significance in relation to large inhomogeneity of particles forming particleboard and OSB. Therefore, special procedures of the material homogenization should be performed before forming samples (e.g., Gupta et al. 2003). The required homogenization of

the material is usually hard to perform for wood-based panels. Another difficulty related to preparation of samples is evacuation of air from a sample pan. The DSC application for investigating hygroscopic materials implies intensive water evaporation from the investigated samples (e.g., Li et al. 2013). It results in uncontrolled changes in determined values for successive repetitions of measurements. Consequently, the requirement for investigation of oven dry samples is formulated (e.g., Gupta et al. 2003; Li et al. 2013). The disadvantages of the DSC application can be overcome when using traditional calorimetric methods.

The objective of the study was to determine the specific heat of wood-based panels. In order to increase the accuracy of the specific heat measurements, the water calorimeter was properly designed and manufactured.

Materials and methods

The requirements for accurate measurements of specific heat of wood-based panels practically cannot be met by an application of commercially available calorimeters. Therefore, in the present study a calorimeter was designed and constructed. Wood-based panels are characterized by relatively low heat capacity which results in small amount of heat released during calorimetric measurements. It implies the requirement for the application of samples of high mass. Another problem related to the calorimetric measurements is a proper selection of a medium used for exchanging heat between a sample and an inner cup of a calorimeter. It was decided in the reported study to use water as the medium as it ensured relatively intensive heat transfer and reasonably short time for obtaining the equilibrium temperature of the system. The short time has an additional merit of the system as it reduces heat losses and increases accuracy of measurements. However, the application of water in the calorimetric system has an important drawback, i.e., water easily soaks into hygroscopic porous materials and changes their thermal properties. Therefore, surfaces of a sample have to be sealed against water penetration. Heat shrinking membrane was applied in order to provide the sealing. The preliminary analysis of heat transfer was performed for the calorimetric system, and it was assumed that the minimum temperature increase in the calorimetric system has to be equal to 2 K for the initial temperature of a sample and water equal to 80 and 20 °C, respectively. The assumption resulted in estimating the sample size of 0.7 dm³.

Design of the calorimetric system was started with formulating the steady-state heat balance equation. It was assumed that a sample and sealing membrane were releasing heat in the system, while water and the inner cup were gaining it. The heat balance equation was transformed, and the following formula was used to calculate specific heat of investigated wood-based panels:

$$c = \frac{(m_a \cdot c_a + m_{H_2O} \cdot c_{H_2O}) \cdot (t_e - t_{ic}) + m_m \cdot c_m \cdot (t_e - t_{is})}{m \cdot (t_{is} - t_e)} \quad (1)$$

where c (J/kg K)—specific heat of investigated material; c_a (J/kg K)—specific heat of aluminum; c_{H_2O} (J/kg K)—specific heat of water; c_m (J/kg K)—specific heat of

shrinking membrane; m (kg)—mass of investigated material (mass of sample); m_a (kg)—mass of aluminum (calorimeter inner cup with a stirring rod); m_{H_2O} (kg)—mass of water; m_m (kg)—mass of shrinking membrane; t_e (°C)—equilibrium temperature of the calorimetric system; t_{ic} (°C)—initial temperature of the calorimeter with water; t_{is} (°C)—initial temperature of the investigated material (sample).

The absolute error (uncertainty) of the specific heat determination (Δc) was calculated by application of the total differential method (e.g., Taylor 1997). It was less than or equal to the sum of absolute values of specific heat partial derivatives with respect to measured quantities as multiplied by uncertainties of individual measurements. During the experiments, the following quantities were assumed to be measured, i.e., mass m , m_a , m_{H_2O} , m_m as well as temperature t_e , t_{ic} , t_{is} . Therefore, the formula for calculating the absolute error is given as

$$\Delta c \leq \left| \frac{\partial c}{\partial m} \right| \Delta m + \left| \frac{\partial c}{\partial m_a} \right| \Delta m_a + \left| \frac{\partial c}{\partial m_{H_2O}} \right| \Delta m_{H_2O} + \left| \frac{\partial c}{\partial m_m} \right| \Delta m_m + \left| \frac{\partial c}{\partial t_e} \right| \Delta t_e + \left| \frac{\partial c}{\partial t_{ic}} \right| \Delta t_{ic} + \left| \frac{\partial c}{\partial t_{is}} \right| \Delta t_{is}. \quad (2)$$

The performed analysis of the mathematical structure of Eq. (2) clearly showed that the absolute error of the specific heat determination mainly depends on uncertainty of temperature measurements. However, in order to estimate the uncertainty values of specific measurements the relative error of the quantity determination was also defined

$$\delta c = \frac{\Delta c}{c} \cdot 100 \% \quad (3)$$

The estimation of uncertainties of the specific heat determination was performed for the following configuration of the experimental system: the initial temperature of a sample was determined with the type K thermocouple of the uncertainty of 0.1 K, the initial temperature of the calorimeter with water and the equilibrium temperature of the calorimetric system was determined with the type J thermocouple of the uncertainty of 0.02 K, and mass of all components of the calorimetric system was measured with uncertainty of 0.0001 kg. It was found that the relative error δc should not exceed 4 % for such specification of the system. Another option of the experimental system was analyzed—the type J thermocouples were replaced with the type K ones. It resulted in unacceptable increase in the relative error δc to ca. 17 %, i.e., almost five times higher values of the error were estimated. Therefore, the importance of applying the type J thermocouples was clearly demonstrated.

Experimental material was obtained from the following wood-based panels: (a) commercial three-layer particleboard of the thickness of 18 mm and mean oven dry density of 634 kg/m³ (coded as PB1), (b) normal-density laboratory-made one-layer particleboard of reduced density profile of the thickness of 26 mm and mean oven dry density of 754 kg/m³ (coded as PB2), (c) high-density laboratory-made one-layer particleboard of reduced density profile of the thickness of 10 mm and mean oven dry density of 973 kg/m³ (coded as PB3), (d) laboratory-made one-layer low-density fiberboard of the thickness of 20 mm and mean oven dry density of

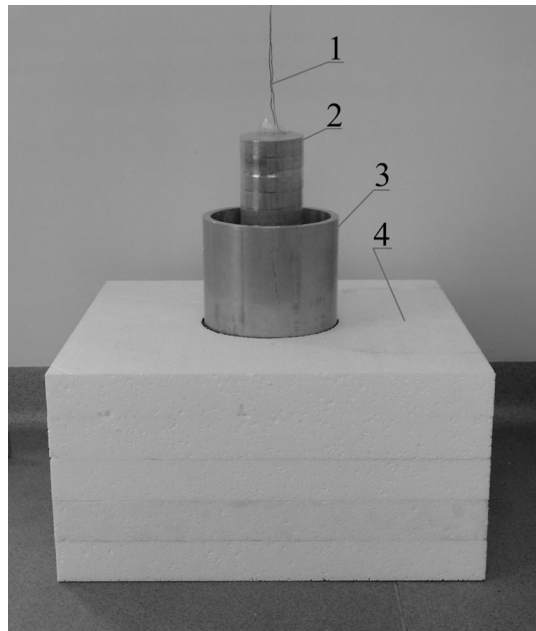
256 kg/m³ (coded as LDF) and (e) commercial oriented strand boards of the thickness of 15 mm and mean oven dry density of 619 kg/m³ (coded as OSB). The material was firstly equilibrated in laboratory conditions, i.e., at temperature of 20 °C and relative humidity of 50 %, and it resulted in moisture content of 6–7 %.

Then, round sheets of 80 mm diameter were cut from all types of the investigated material. The sheets were used to form samples in the shape of cylinders of a height of 135 mm. Two type K thermocouples were mounted in the center and at the surface of each sample. The thermocouples were used to control the temperature distribution in samples and to measure the equilibrium temperature of the sample-calorimeter system. The samples were covered with heat shrinkable membrane of specific heat, which was accounted for in the heat balance of the system.

The performed analysis of uncertainties enabled to construct the cup of the calorimeter. It was in the shape of a cylinder with an inner hole of 4 dm³ volume. The cup was made of the aluminum alloy PA6 characterized by specific heat of 860 J/kg K for temperature range of 17–21 °C. The same material was used for making a stirring rod. Mass of the cup and the stirring rod (m_a) was equal to 4.3002 kg. After mounting the type J and K thermocouples, the cup was tightly placed in a styrofoam block. The minimum thickness of the styrofoam insulation was 12 cm. The applied insulation effectively reduced heat losses of the calorimetric system. The general view of the calorimeter with a sample being placed into water is depicted in Fig. 1.

Before starting the calorimetric experiments, samples were covered with shrinkable membrane and heated up for 18 h in order to obtain the uniform initial temperature of 98 °C. Simultaneously the calorimeter cup was filled with a portion

Fig. 1 General view of the water calorimeter: 1—thermocouples type J and K, 2—sample sealed with heat shrinking membrane, 3—inner aluminum cup, 4—styrofoam block



of distilled water of mass $m_{\text{H}_2\text{O}}$. The water in the cup was frequently stirred, and after 2 h, the initial temperature of the calorimeter with water was obtained. Next, a sample with uniform initial temperature was placed in the cup and immersed in water. The top of the calorimeter was covered with styrofoam insulation. Water in the cup was again frequently stirred, and measurements of temperature t_e were started. The equilibrium temperature was usually obtained after 3 h. The experimental procedure was repeated five times for each type of the investigated material.

Results

The results of the performed calorimetric experiments are presented in Table 1. The specific heat values of all investigated materials were calculated with Eq. (1). The obtained results were supplemented by the absolute and relative errors (Table 1).

The mean values of specific heat of LDF, PB1, PB2 and PB3 were similar and varying from 1420 to 1450 J/kg K despite different density, moisture content and resin content of the investigated panels. The obtained mean value of the specific heat of OSB was equal to 1552 J/kg K and higher as compared to other investigated materials. Moreover, the analysis of the error values clearly demonstrated that the assumed high accuracy of the specific heat measurements was obtained.

The individual and mean values of the specific heat were supplemented by the estimated values of absolute and relative errors (Table 1). The analysis of the observed errors showed that the inaccuracy of the specific heat measurements increased with the decrease in mass of samples of the investigated materials. The highest values of absolute and relative errors of ca. 50 J/kg K and 4 % were found for LDF which was characterized by the lowest density. Contrary to that, the lowest values of the errors of ca. 20 J/kg K and 1.5 % were found for particleboard PB3, which was characterized by the highest density. The observations clearly supported the earlier assumption of performing the measurements for samples with high mass.

The measured values of specific heat were also compared to the data available in the literature. Nanassy and Szabo (1978) reported data on the specific heat for wood-based panels characterized by density and moisture content being similar to the panels investigated in the present study. It was found that the measured values were ca. 100 J/kg K lower than the results discussed by Nanassy and Szabo (1978). Baryeh (1997) discussed the influence of density of wood-based panels on their specific heat. It was clearly shown that the specific heat values increased with the density increase. It is contrary to the current observations reported in Table 1 where the density had no significant influence on the measured values. Therefore, the data reported by Baryeh (1997) were much higher as compared to the results presented in Table 1. The differences were equal to ca. 500 J/kg K for density of ca. 600 kg/m³ (e.g., PB1) as well as ca. 1600 J/kg K for density of ca. 1000 kg/m³ (e.g., PB3).

The specific heat data of wood-based panels are also given in the form of empirical models being functions of density and, in some cases, temperature. Again the comparison was made between the results presented in Table 1 and the specific heat values calculated from the models reported by Ward and Skaar (1963) as well as by TenWolde et al. (1988). Practically insignificant differences were noticed

Table 1 Measured values of the heat balance components together with calculated specific heat, absolute error and relative error

Codes	m_{H_2O} (kg)	m (kg)	m_m (kg)	t_{ic} (°C)	t_{is} (°C)	t_e (°C)	ΔT (K)	c (J/kg K)	Δc (J/kg K)	δc (%)
PB1	3.5283	0.3894	0.0120	17.52	98.0	19.94	2.42	1434	27.28	1.90
	3.3212	0.3792	0.0150	17.88	98.8	20.38	2.50	1434	26.69	1.86
	3.3410	0.3781	0.0146	18.28	98.6	20.76	2.48	1445	27.08	1.87
	3.3560	0.3787	0.0124	17.88	98.2	20.34	2.46	1442	27.10	1.88
	3.2554	0.3792	0.0129	17.22	99.0	19.80	2.58	1449	26.08	1.80
							Mean value	1441	26.85	1.86
PB2	3.3478	0.4285	0.0112	16.96	99.3	19.76	2.80	1424	23.64	1.66
	3.5860	0.4245	0.0112	17.22	99.4	19.84	2.62	1421	25.00	1.76
	3.3116	0.4262	0.0138	17.60	98.9	20.38	2.78	1421	23.88	1.68
	3.3322	0.4281	0.0124	17.64	99.1	20.42	2.78	1423	23.83	1.68
	3.3008	0.4300	0.0127	17.82	99.2	20.64	2.82	1428	23.63	1.66
							Mean value	1423	24.00	1.69
PB3	3.5214	0.5784	0.0106	17.34	96.0	20.82	3.48	1454	19.81	1.36
	3.5266	0.5784	0.0106	17.36	98.1	20.92	3.56	1451	19.33	1.33
	3.5148	0.5784	0.0106	17.08	98.3	20.66	3.58	1446	19.16	1.33
	3.5508	0.5784	0.0106	17.40	97.1	20.90	3.50	1452	19.66	1.35
	3.2932	0.5407	0.0101	17.46	93.5	20.76	3.30	1445	20.73	1.43
							Mean value	1450	19.74	1.36
LDF	3.1434	0.1878	0.0139	17.88	97.2	19.18	1.30	1409	49.81	3.53
	3.3404	0.1864	0.0129	17.98	95.8	19.20	1.22	1430	53.41	3.73
	3.1918	0.1870	0.0126	17.76	88.5	18.90	1.14	1416	56.50	3.99
	3.2936	0.1888	0.0129	18.20	97.6	19.46	1.26	1414	51.18	3.62
	3.2936	0.1867	0.0128	17.26	97.8	18.54	1.28	1433	51.06	3.56
							Mean value	1420	52.39	3.69
OSB	3.3444	0.4144	0.0139	18.00	98.1	20.86	2.86	1542	25.28	1.64
	3.3560	0.4144	0.0139	17.26	98.3	20.20	2.94	1573	25.13	1.60
	3.3756	0.4120	0.0125	17.72	97.7	20.50	2.78	1523	25.55	1.68
	3.3450	0.4118	0.0122	17.64	98.1	20.54	2.90	1572	25.38	1.61
	3.2994	0.4139	0.0130	16.66	98.0	19.60	2.94	1550	24.73	1.60
							Mean value	1552	25.21	1.62

when comparing the data. However, it has to be emphasized that the model reported by TenWolde et al. (1988) was originally developed for solid wood. It has special importance when considering the observation reported by Kamke and Zylkowski (1989) that the thermal properties of wood-based panels are different from the solid wood of which the panels were made. Therefore, special caution has to be given

when applying such empirical models as it can significantly influence the accuracy of specific heat values calculated from the model.

Resin type and content are another possible factor influencing specific heat of wood-based panels. However, these two parameters are frequently skipped when considering thermal properties of the panels. It is primarily due to problems in obtaining credible data on the resin content. Therefore, the thermal properties of wood-based panels are often adapted from the properties of solid wood. For instance, Kawasaki and Kawai (2006) assumed the specific heat as equal to 1500 J/kg K regardless of wood-based panels or solid wood and their density.

The evaluation of the credibility of the measured values of specific heat can only be made when applying the data to model transient heat transfer in wood-based panels and comparing results of modeling to experiments. However, it can be performed when determining thermal conductivity of the investigated panels (Czajkowski et al. 2016).

Conclusion

1. The designed and constructed calorimeter enabled to perform measurements of the specific heat of wood-based panels with accuracy estimated by the relative error being less than 2 % for all types of the investigated particleboard and OSB. In the case of LDF, the maximum value of the relative error did not exceed 4 %.
2. It was clearly presented that the required high accuracy of the specific heat measurements could be obtained for experiments made with samples of high mass. It was in contrast to measurements traditionally made with samples used in DSC systems.
3. The measured values of the specific heat were within the range from 1420 to 1450 J/kg K for LDF, PB1, PB2 and PB3. Moreover, the influence of density of the investigated materials on their specific heat was not found. The only exception was OSB which was characterized by the specific heat of ca. 1550 J/kg K, and it was ca. 100 J/kg K higher when compared to other panels.

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